

GIGALIGHT 25Gbps SFP28 hardened active optical cable P/N: GSS-MDO250-xxxT

Features

✓ Supports SFF8431/SFF8432/SFF8472,I²C

management interface

- ✓ Hot-pluggable SFP28 form factor , supports 25Gbps data rate
- ✓ Maximum link length of 70m on

OM3 MMF

- ✓ 850nm VCSEL laser and PIN photo-detector
- Internal CDR on both Transmitter and Receiver channel
- ✓ Single 3.3V power supply
- ✓ Power dissipation < 1W</p>
- ✓ RoHS compliant Ø
- ✓ Commercial case temperature range: -40°C to +85°C
- ✓ Hardened active optical cable with metal tube and Kevlar strengthen

Applications

- 25 Gigabit Ethernet
- EDR Infiniband
- High-performance computing clusters
- · Servers, switches, storage and host card adapters

Description

Gigalight GSS-MDO250-xxxT SFP28 Hardened Active Optical Cables are direct-attach fiber assemblies with SFP28 connectors. They are suitable for short distances & strengthen application with hardened optical cable, it offers a cost-effective way to connect within racks and across adjacent racks.

Gigalight SFP28 Hardened Active Optical Cables is made of hardened optical cable structure with stainless steel metal tube,Kevlar strenthen and LSZH Jacket ,support up to 70 meters on OM3 MMF,







it's specially for outstanding long term reliability and harsh environment tolerance. **Block Diagram**

Absolute Maximum Ratings

Table 1 - Absolute Maximum Ratings

| Parameter | Symbol | Min | Мах | Unit |
|----------------------------|--------|-----|-----|------|
| Supply Voltage | Vcc | 0 | 3.6 | V |
| Storage Temperature | Ts | -20 | +85 | °C |
| Operating Case Temperature | С | -40 | +85 | °C |
| Operating Humidity | - | 5 | 85 | % |
| Dynamic Bending Radius | Dbr | | 20D | mm |
| Static Bending Radius | Sbr | | 10D | mm |

Specifications and Recommended Operating Conditions Table 2 – Specifications and Recommended Operating Conditions

| Parameter | Min | Typical | Max | Unit | Notes |
|------------------------------|------|---------|------|-------|-----------------|
| Power supply voltage | 3.13 | 3.3 | 3.47 | V | |
| Supply current | | 300 | | mA | per end typical |
| Channel Data Rate | | 25.78 | | Gbps | |
| Optical cable outer diameter | | 3.0 | | mm | |
| Optical cable loss | | | 3.5 | dB/km | OM3 |

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| Tensile 1 | 300 | Ν | Long Term |
|--------------------|------|---------|------------|
| Tensile 2 | 600 | Ν | Short Term |
| Crush Resistance 1 | 2000 | N/100mm | Long Term |
| Crush Resistance 1 | 3000 | N/100mm | Short Term |

Optical and Electrical Characteristics

Table 3 - Optical and Electrical Characteristics

| | imeter | Symbol | Min | Typical | Max | Unit | Notes | |
|----------------------------|-----------------|--------------------|--------|---------|------|------|-------|--|
| | Transmitter | | | | | | | |
| Data | a rate | BR | | 25.78 | | Gbps | | |
| Centre V | Vavelength | λc | 840 | 850 | 860 | nm | | |
| Spectral W | /idth (-20dB) | σ | | | 0.6 | nm | | |
| Average O | utput Power | Pavg | -8.4 | | 2.4 | dBm | | |
| Optical P | ower OMA | Рома | -6.4 | | 3 | dBm | | |
| Extinct | ion Ratio | ER | 2 | | | dB | | |
| Differential da | ata input swing | V _{IN,PP} | 40 | | 1000 | mV | | |
| Input Differer | tial Impedance | Z _{IN} | 90 | 100 | 110 | Ω | | |
| TX Disable | Disable | | 2.0 | | Vcc | V | | |
| | Enable | | 0 | | 0.8 | V | | |
| TX Fault | Fault | | 2.0 | | Vcc | V | | |
| | Normal | | 0 | | 0.8 | V | | |
| | | | Receiv | er | | | | |
| Data | a rate | BR | | 25.78 | | Gbps | | |
| Centre V | Vavelength | λc | 840 | 850 | 860 | nm | | |
| Receiver Ser | nsitivity (OMA) | Psens | - | - | -10 | dBm | | |
| Stressed Sensitivity (OMA) | | | - | - | -5.2 | dBm | | |
| Receiver Power (OMA) | | | | | 3 | dBm | | |
| LOS De-Assert | | LOSD | | | -13 | dBm | | |
| LOS | Assert | LOS _A | -30 | | | dBm | | |
| LOS H | ysteresis | | 0.5 | | | dB | | |
| Differentia | l data output | Vout,PP | 300 | | 850 | mV | | |

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| swing | | | | | |
|-------|------|-----|-----|---|--|
| LOS | High | 2.0 | Vcc | V | |
| | Low | | 0.8 | V | |

Notes:

Receive Sensitivity measured with a prbs31 pattern @25.78125Gb/s, BER 1E-5.

Timing and Electrical

Table 4 - Timing and Electrical

| Parameter | Symbol | Min. | Max. | Unit | Conditions |
|---|-----------------------|------|------|------|---|
| Tx_Disable assert time | t_off | | 100 | μs | Rising edge of Tx_Disable to fall of output signal below 10% of nominal |
| Tx_Disable negate time | t_on | | 2 | ms | Falling edge of Tx_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery. |
| Time to initialize 2-wire interface | t_2w_start_up | | 300 | ms | From power on or hot plug after the supply meet- ing Table 8. |
| Time to initialize | t_start_up | | 300 | ms | From power supplies meeting <u>Table 8</u> or hot plug or Tx disable negated during power up, or Tx_Fault recovery, until non-cooled power level I part (or non-cooled power level II part already enabled at power level II for Tx_Fault recovery) is fully operational. |
| Time to initialize cooled module and time to power up a cooled module to Power Level II | t_start_up_cooled | | 90 | s | From power supplies meeting <u>Table 8</u> or hot plug, or Tx disable negated during power up or Tx_Fault recovery, until cooled power level I part (or cooled power level II part during fault recovery) is fully operational. Also, from stop bit low-to-high SDA transition enabling Power Level II until cooled module is fully operational |
| Time to Power Up to Level II | t_power_level2 | | 300 | ms | From stop bit low-to-high SDA transition enabling power level II until non-cooled module is fully operational |
| Time to Power Down from Level II | t_power_down | | 300 | ms | From stop bit low-to-high SDA transition dis- abling power level II until module is within power level I requirements |
| Tx_Fault assert | Tx_Fault_on | | 1 | ms | From occurrence of fault to assertion of Tx_Fault |
| Tx_Fault assert for cooled module | Tx_Fault_on_cooled | | 50 | ms | From occurrence of fault to assertion of Tx_Fault |
| Tx_Fault Reset | t_reset | 10 | | μs | Time Tx_Disable must be held high to reset Tx_Fault |
| RS0, RS1 rate select timing for FC | t_RS0_FC, t_RS1_FC | | 500 | μs | From assertion till stable output |
| RS0, RS1 rate select timing non FC | t_RS0, t_RS1 | | 24 | ms | From assertion till stable output |
| Rx_LOS assert delay | t_los_on | | 100 | μs | From occurrence of loss of signal to assertion of Rx_LOS |
| Rx_LOS negate delay | t_los_off | | 100 | μs | From occurrence of presence of signal to negation of Rx_LOS |



Diagnostics

Table 5 – Diagnostics Specification

| Parameter | Range | Unit | Accuracy | Calibration |
|--------------|------------|------|-------------|---------------------|
| Temperature | -40 to +85 | °C | ±3 ℃ | Internal / External |
| Voltage | 3.0 to 3.6 | V | ±3% | Internal / External |
| Bias Current | 0 to 20 | mA | ±10% | Internal / External |
| TX Power | -8 to 3 | dBm | ±3dB | Internal / External |
| RX Power | -14 to 0 | dBm | ±3dB | Internal / External |

Digital Diagnostic Memory Map

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.





Pin Definitions





Pin Descriptions

| PIN | Logic | Symbol | Name / Description | Note |
|-----|-----------|----------|---|------|
| 1 | | VeeT | Module Transmitter Ground | 1 |
| 2 | LVTTL-O | TX_Fault | Module Transmitter Fault | 2 |
| 3 | LVTTL-I | TX_Dis | Transmitter Disable; Turns off transmitter laser output | |
| 4 | LVTTL-I/O | SDA | 2-Wire Serial Interface Data Line | 2 |
| 5 | LVTTL-I | SCL | 2-Wire Serial Interface Clock | 2 |



| 6 | | MOD_ABS | Module Definition, Grounded in the module | |
|----|---------|---------|---|---|
| 7 | LVTTL-I | RS0 | Receiver Rate Select | |
| 8 | LVTTL-O | RX_LOS | Receiver Loss of Signal Indication Active LOW | |
| 9 | LVTTL-I | RS1 | Transmitter Rate Select (not used) | |
| 10 | | VeeR | Module Receiver Ground | 1 |
| 11 | | VeeR | Module Receiver Ground | 1 |
| 12 | CML-O | RD- | Receiver Inverted Data Output | |
| 13 | CML-O | RD+ | Receiver Data Output | |
| 14 | | VeeR | Module Receiver Ground | 1 |
| 15 | | VccR | Module Receiver 3.3 V Supply | |
| 16 | | VccT | Module Receiver 3.3 V Supply | |
| 17 | | VeeT | Module Transmitter Ground | 1 |
| 18 | CML-I | TD+ | Transmitter Non-Inverted Data Input | |
| 19 | CML-I | TD- | Transmitter Inverted Data Input | |
| 20 | | VeeT | Module Transmitter Ground | 1 |

Notes:

1. Module ground pins GND are isolated from the module case.

2. Shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.45V on the host board.



Recommended Interface Circuit







Mechanical Dimensions



| 光缆结林 Cable s | 句 tructure | 材质/型号 Material /model | 规格 Specifications | |
|-----------------|------------------------------|--------------------------|----------------------|------------|
| 1 | 光纤Optical Fiber | G652D/OM3 | 2-Φ0.6±0.05 | (2) |
| | | | 0. D | Φ1.85±0.1 |
| 2 | 铠管Metal Tube | 不锈钢Stainless steel | I.D | Φ1.35±0.05 |
| | and the second second second | and the second second | 厚度/Thickness | 0.22±0.02 |
| 3 | 加强件Strengthen | 凯孚拉Kevlar | 1100DTEX | |
| | 4 披覆Jacket | LSZH | 直径Diameter | Φ3.0±0.1 |
| 4 | 12復JacKet | LS2H | 厚度/Thickness | ≥0.4 |



Regulatory Compliance

Gigalight GSS-MDO250-xxxT Active Optical Cable are Class 1 Laser Products. They meet the requirements of the following standards.

| Feature | Standard |
|--------------------------|--|
| Laser Safety | IEC 60825-1:2014 (3 rd Edition) IEC 60825-2:2004/AMD2:2010 EN 60825-1-2014 EN 60825-2:2004+A1+A2 |
| Electrical Safety | EN 62368-1: 2014 IEC 62368-1:2014 UL 62368-1:2014 |
| Environmental protection | Directive 2011/65/EU with amendment(EU)2015/863 |
| CE EMC | EN55032: 2015 EN55035: 2017 EN61000-3-2:2014 EN61000-3-3:2013 |
| FCC | FCC Part 15, Subpart B ANSI C63.4-2014 |

References

- 1. SFP MSA
- 2. 25GBASE-SR

3. Directive 2011/65/EU of the European Parliament and of the Council, "on the restriction of the use of certain hazardous substances in electrical and electronic equipment," July 1, 2011.

Ordering information

| Part Number | Product Description | | | |
|---|--|--|--|--|
| GSS-MDO250-xxxT | 25Gbps, 850nm; SFP28 Hardened AOC with metal tube and Kevlar strengthen,OM3 fiber, -40 $^\circ\!\mathrm{C}$ ~ +85 $^\circ\!\mathrm{C}$ | | | |
| xxx :001~070, Length in meters on OM3 MMF | | | | |
| The optical fiber structure can be customized, further details are available from any Gigalight sales representative. | | | | |



CAUTION:

Use of controls or adjustment or performance of procedures other than those specified herein may result in hazardous radiation exposure.

Important Notice

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Revision History

| Revision | Date | Description |
|----------|--------------|------------------|
| V0 | Feb-28- 2022 | Advance Release. |